VE 320 Fall 2021

Introduction to Semiconductor Devices

Instructor: Rui Yang (杨睿)

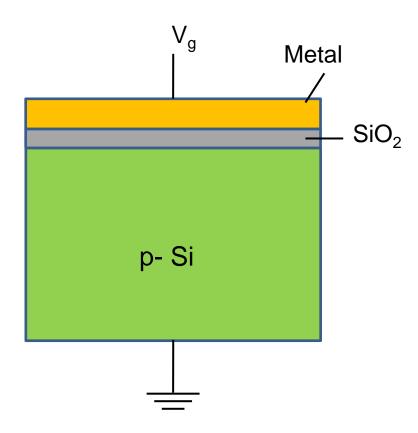
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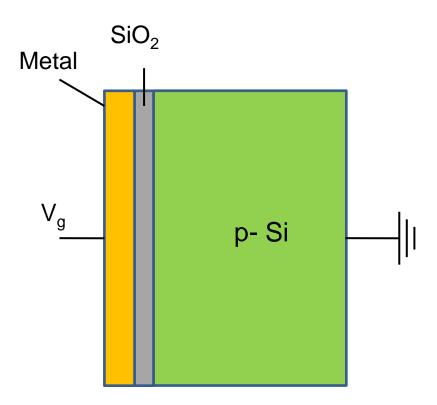
Lecture 11

MOS Capacitor (Chapter 10)



Metal-oxide-semiconductor (MOS)

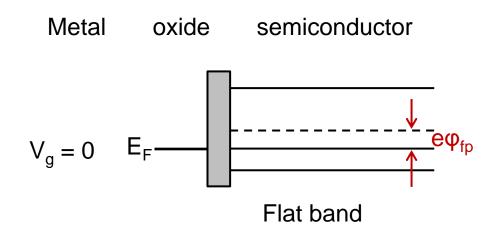
MOS capacitor



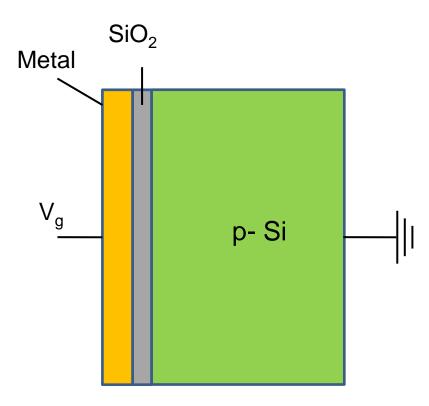
Metal-insulator-semiconductor (MIS)

Ideal case:

- 1. Metal and semiconductor have the same work function $\Phi_{\rm m} = \Phi_{\rm s}$
- 2. No interface states or surface states



MOS capacitor

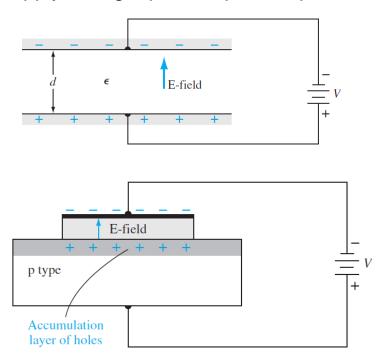


Metal-insulator-semiconductor (MIS)

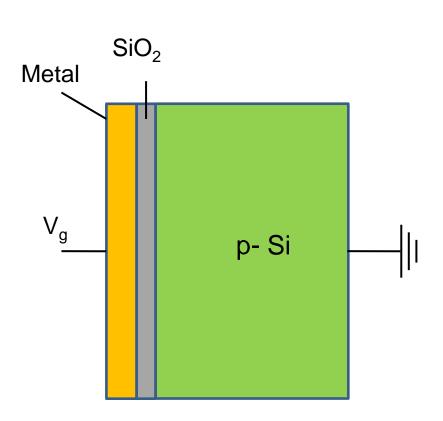
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- 2. No interface states or surface states

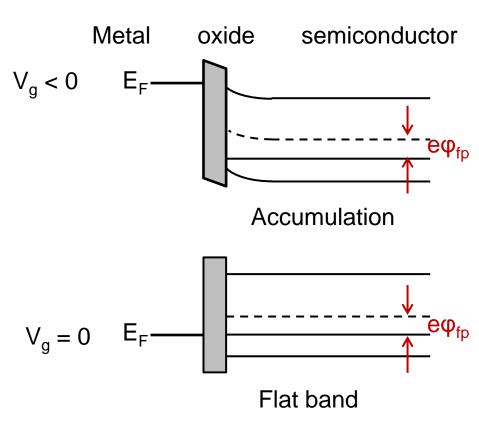
Apply voltage: parallel-plate capacitor



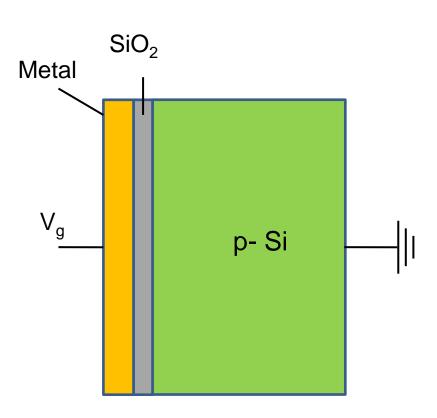
MOS capacitor



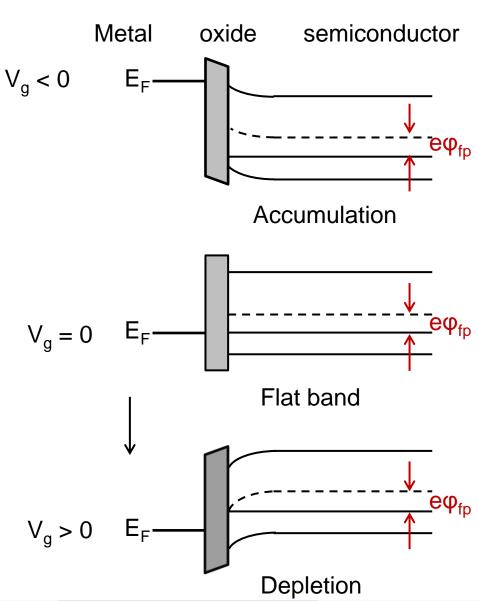
Metal-insulator-semiconductor (MIS)

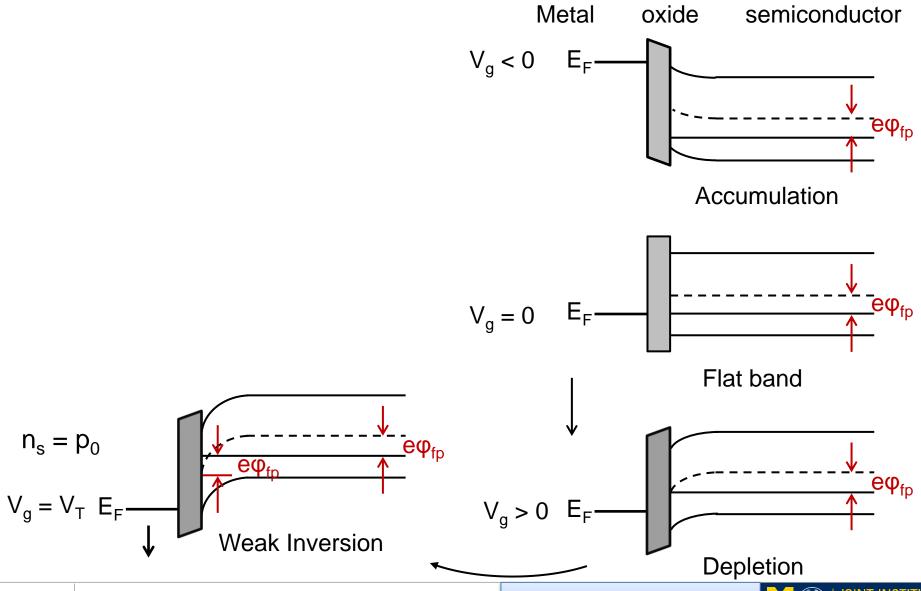


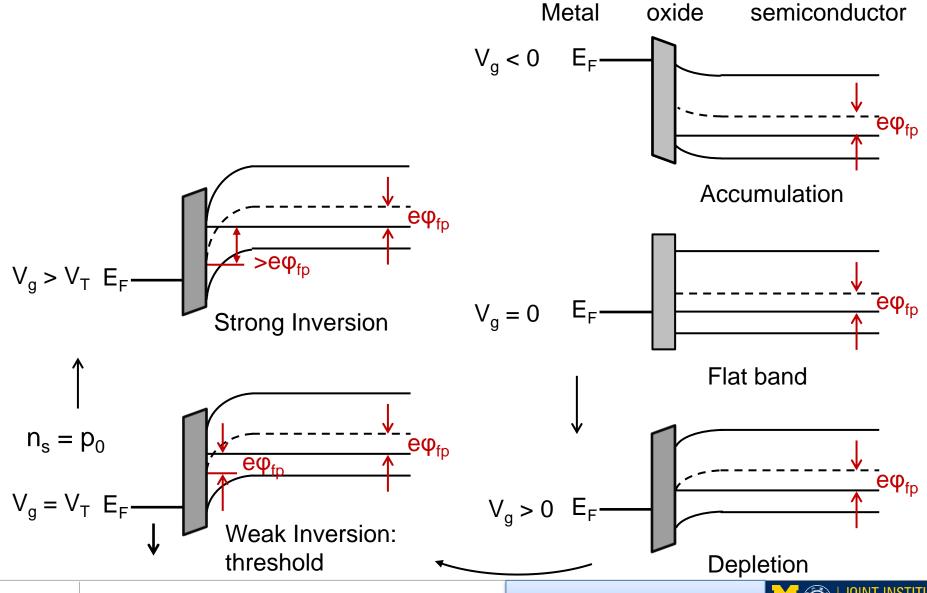




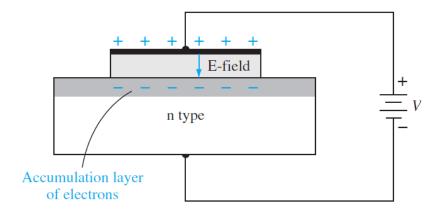
Metal-insulator-semiconductor (MIS)

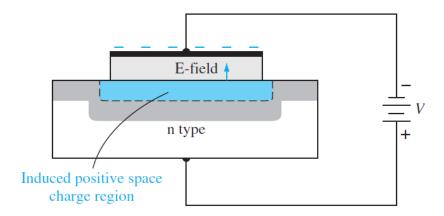




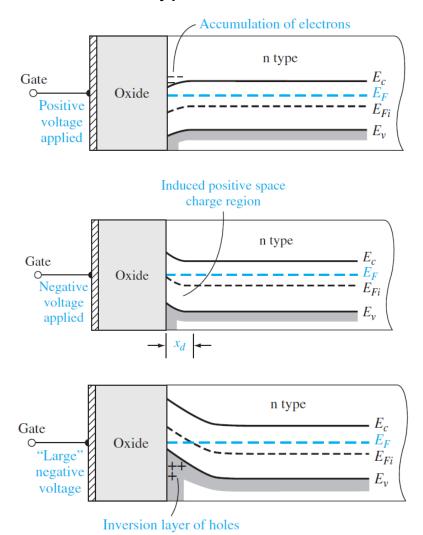


Similarly, if the substrate is n-type Si:



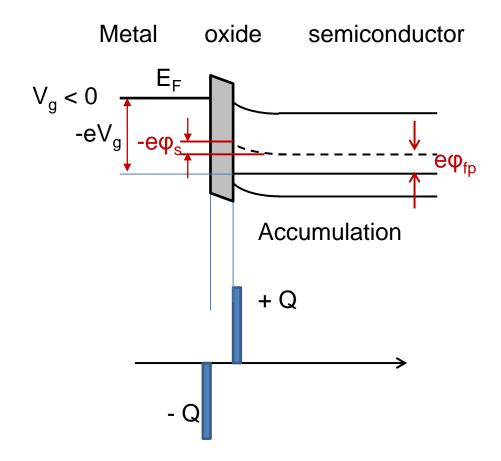


Similarly, if the substrate is n-type Si:



Charge Distribution

Accumulation

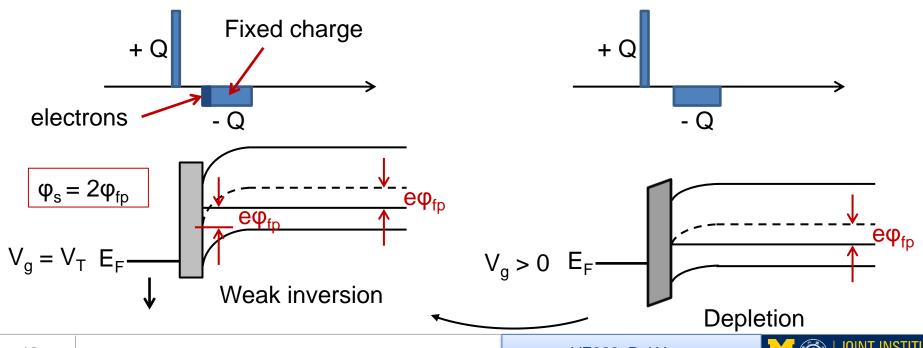


Charge Distribution

Depletion and weak inversion

Threshold inversion point:

Electron concentration at the surface is the same as the hole concentration in the bulk V_T : threshold voltage



Strong inversion $e\phi_s$ E_F $\emptyset_s > 2\emptyset_{fp}$ Fixed charge +Q electrons ·

Charge density:

$$n = n_i \exp\left[\frac{E_F - E_{Fi}}{kT}\right]$$

At the surface:

$$n_s = n_i \exp\left[\frac{e(\phi_{fp} + \Delta\phi_s)}{kT}\right] = n_i \exp\left[\frac{\phi_{fp} + \Delta\phi_s}{V_t}\right]$$

$$n_s = n_i \exp\left(\frac{\phi_{fp}}{V_t}\right) \cdot \exp\left(\frac{\Delta\phi_s}{V_t}\right)$$

 $\Delta arPhi_{
m s}$ is the surface potential greater than $2 arPhi_{
m fp}$

Write
$$n_{st} = n_i \exp\left(\frac{\phi_{fp}}{V_t}\right)$$

is the surface charge density at the threshold inversion point

$$n_s = n_{st} \exp\left(\frac{\Delta \phi_s}{V_t}\right)$$

Width of the space charge region (p-type substrate)

Distance between $E_{\rm Fi}$ and $E_{\rm F}$

$$\phi_{fp} = V_t \ln \left(\frac{N_a}{n_i} \right)$$

Surface potential (difference between E_{Fi} measured in bulk and measured at the surface): φ_s , or the amount of band bending

Space charge width: similar to one-sided pn junction (assume abrupt depletion)

$$x_d = \left(\frac{2\epsilon_s \phi_s}{eN_a}\right)^{1/2}$$

Maximum space charge width at the inversion transition point:

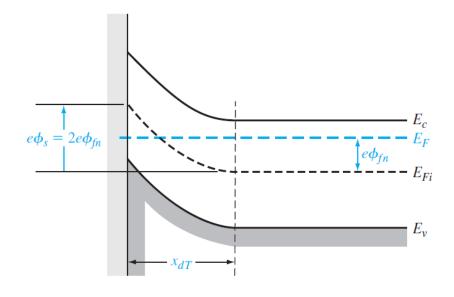
$$x_{dT} = \left(\frac{4\epsilon_s \phi_{fp}}{eN_a}\right)^{1/2}$$

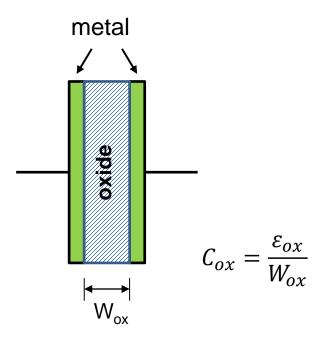
Width of the space charge region (n-type substrate)

$$\phi_{fn} = V_t \ln \left(\frac{N_d}{n_i} \right)$$

Maximum space charge width at the inversion transition point:

$$x_{dT} = \left(\frac{4\epsilon_s \phi_{fn}}{eN_d}\right)^{1/2}$$



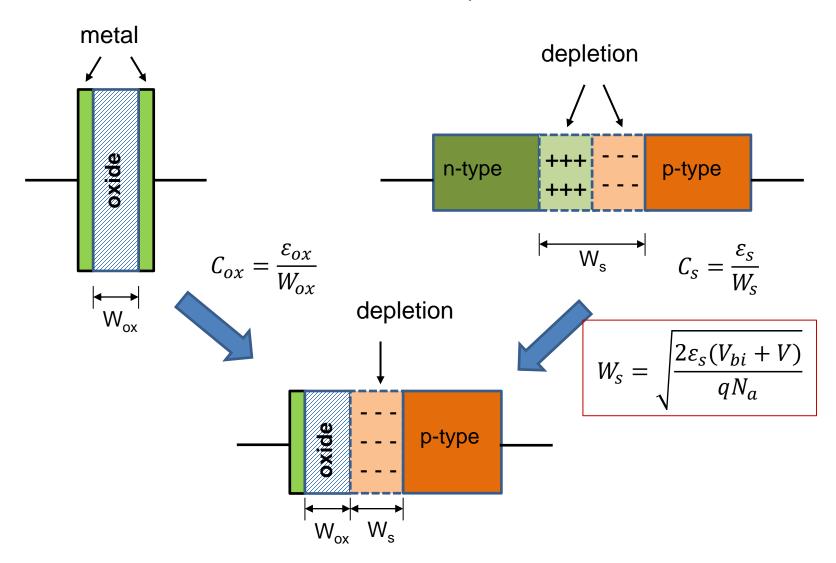


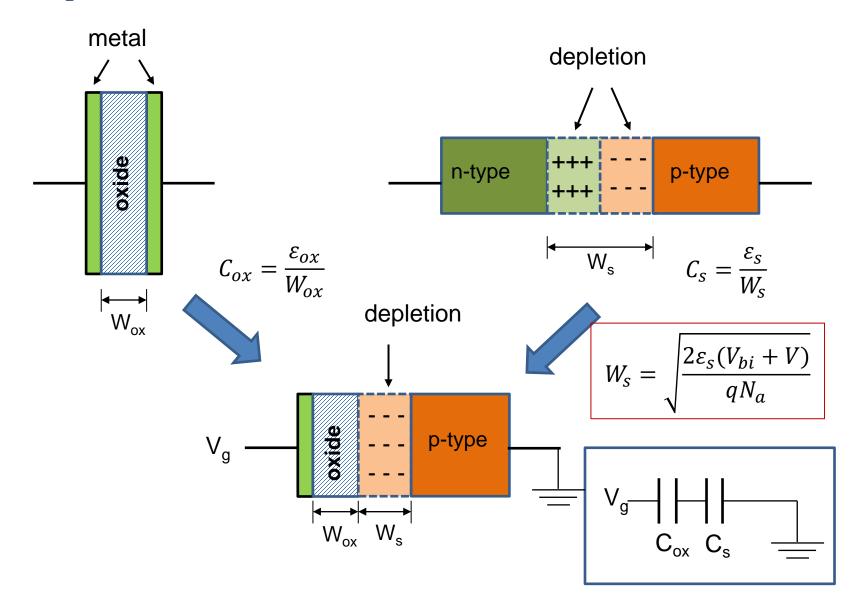
In accumulation:

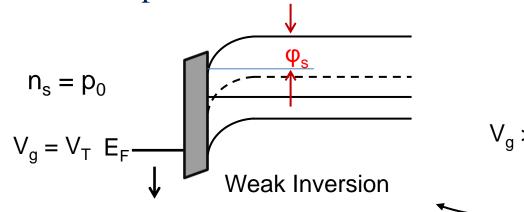
$$C'(\mathrm{acc}) = C_{\mathrm{ox}} = \frac{\epsilon_{\mathrm{ox}}}{t_{\mathrm{ox}}}$$

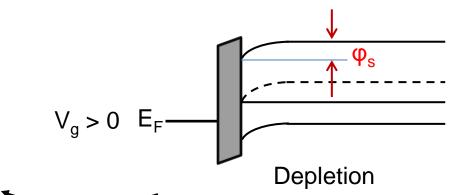
Capacitance per unit area

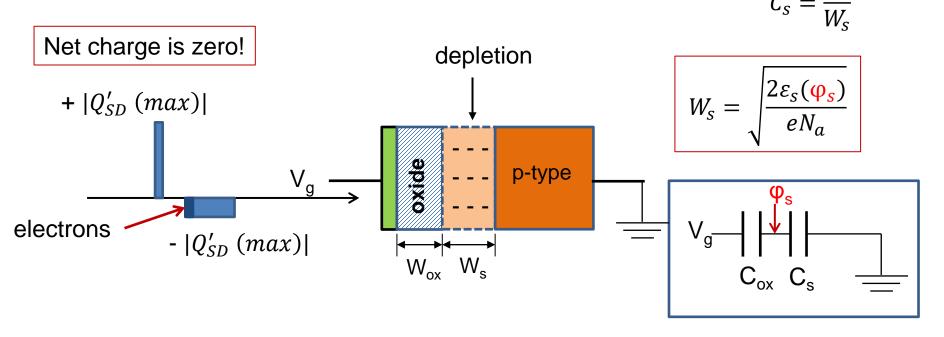
With depletion:



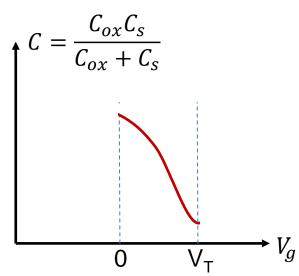


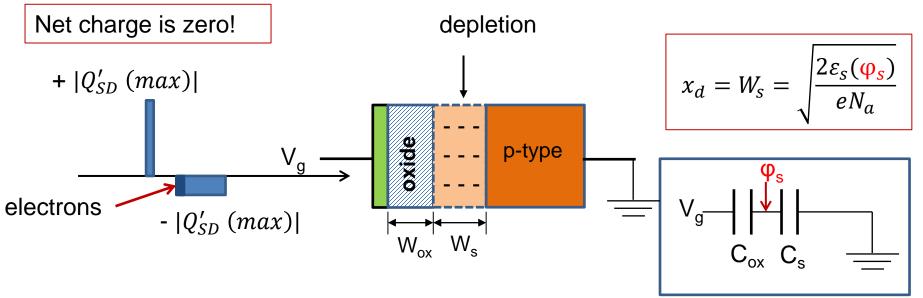






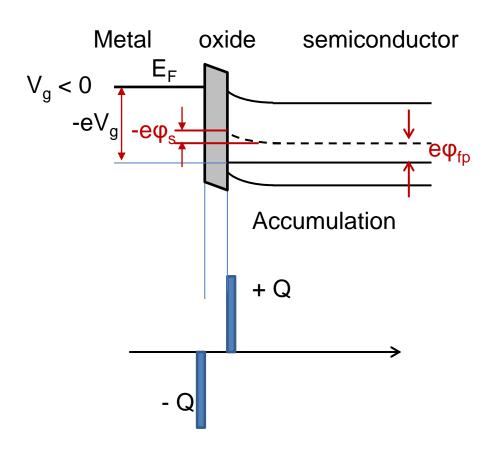
$$\begin{cases}
 \phi_s = \frac{V_g C_{ox}}{C_{ox} + C_s} \\
 C_s = \frac{\varepsilon_s}{\sqrt{\frac{2\varepsilon_s(\phi_s)}{eN_a}}}
\end{cases}$$

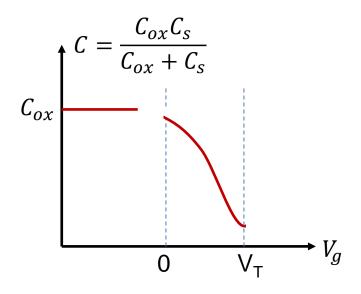




Previously...Charge Distribution

Accumulation

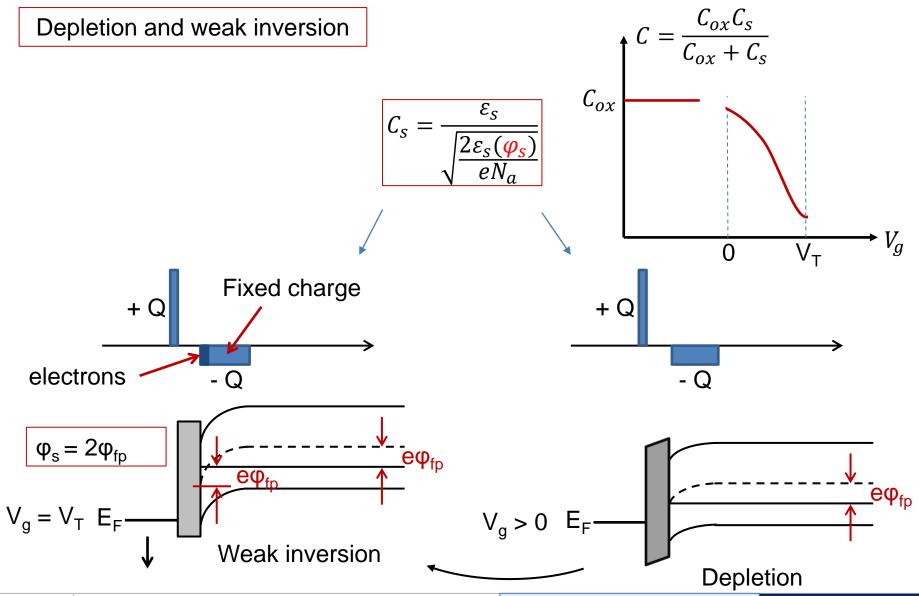




$$C_s \rightarrow \infty$$

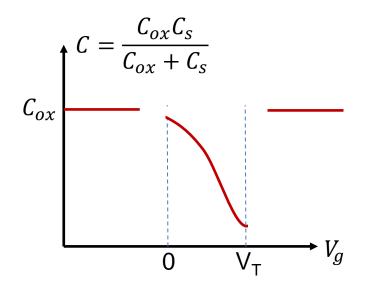
$$C = \frac{C_s C_{ox}}{C_s + C_{ox}} \approx C_{ox}$$

Previously...Charge Distribution



Previously...Charge Distribution

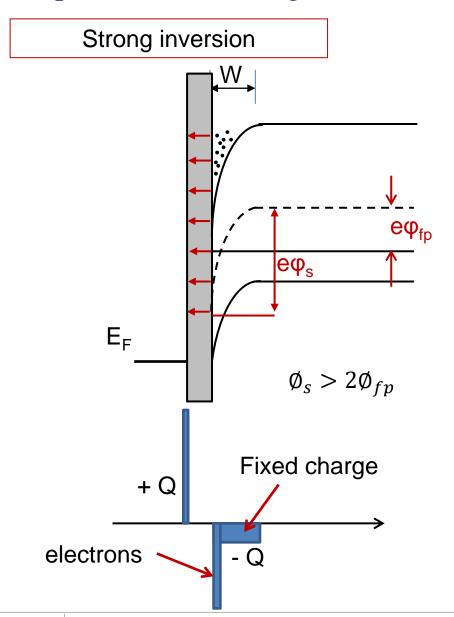
Strong inversion $e\phi_{fp}$ eφ_s E_F $\emptyset_s > 2\emptyset_{fp}$ Fixed charge +Q electrons

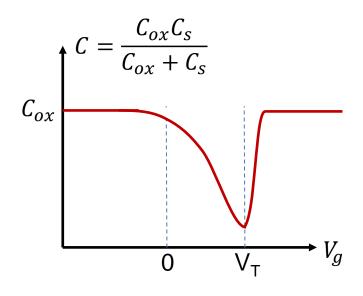


$$C_S \rightarrow \infty$$

$$C = \frac{C_s C_{ox}}{C_s + C_{ox}} \approx C_{ox}$$

Capacitance vs Voltage (CV) curve





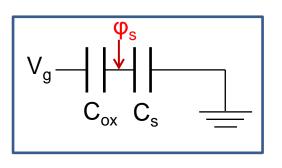
$$C_s \rightarrow \infty$$

$$C = \frac{C_s C_{ox}}{C_s + C_{ox}} \approx C_{ox}$$

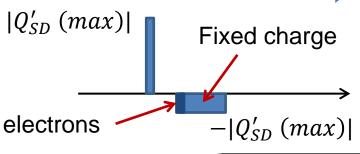
Threshold Voltage (V_T)

Ideal case:

Metal and p-type semiconductor have the same work function $\Phi_m = \Phi_s$



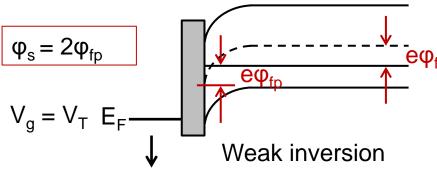
$$C_{s} = \frac{\varepsilon_{s}}{\sqrt{\frac{2\varepsilon_{s}(\varphi_{s})}{eN_{a}}}} = \frac{\varepsilon_{s}}{\sqrt{\frac{2\varepsilon_{s}(2\varphi_{fp})}{eN_{a}}}}$$



$$|Q'_{SD}(max)| = (V_T - 2\varphi_{fp}) C_{ox}$$

$$V_T = 2\varphi_{fp} + \frac{|Q'_{SD}(max)|}{C_{ox}}$$

$$V_T = 2\varphi_{fp} + \frac{2\sqrt{e\varepsilon_s N_a \varphi_{fp}}}{C_{ox}}$$



Threshold Voltage (V_T)

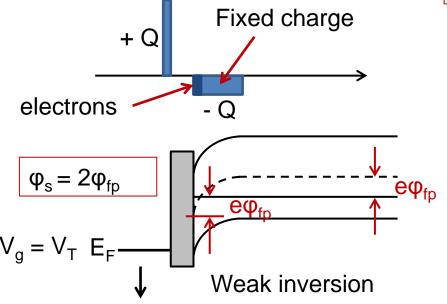
If metal and semiconductor have different work function: $\Phi_m \neq \Phi_s$

$$C_{s} = \frac{\varepsilon_{s}}{\sqrt{\frac{2\varepsilon_{s}(\varphi_{s})}{eN_{a}}}} = \frac{\varepsilon_{s}}{\sqrt{\frac{2\varepsilon_{s}(2\varphi_{fp})}{eN_{a}}}}$$

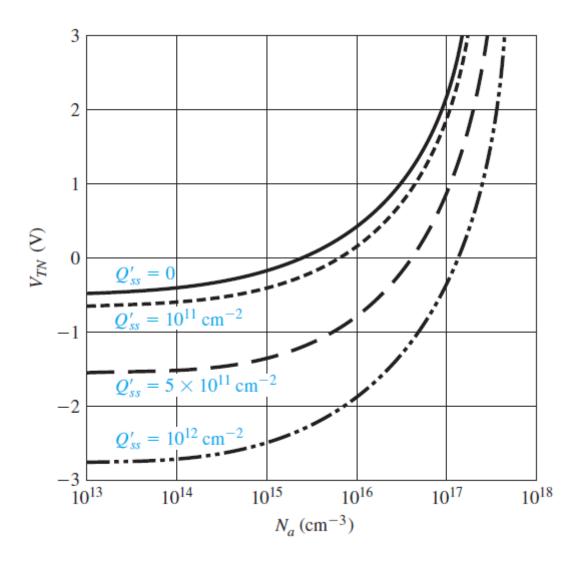
$$|Q'_{SD}(max)| = (V_T - 2\varphi_{fp}) C_{ox}$$

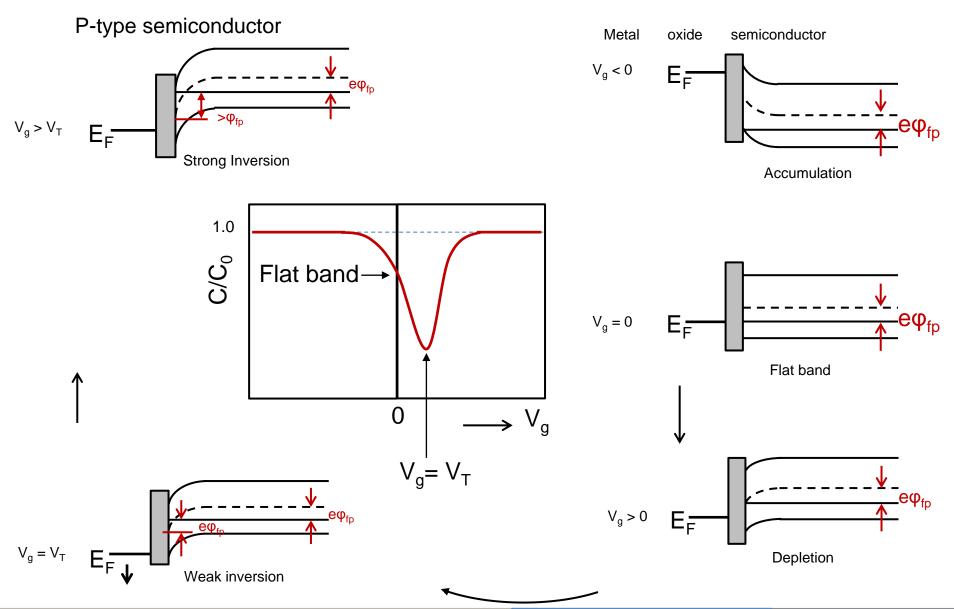
$$V_{TN} = \frac{|Q'_{SD}(\text{max})|}{C_{ox}} + V_{FB} + 2\phi_{fp}$$

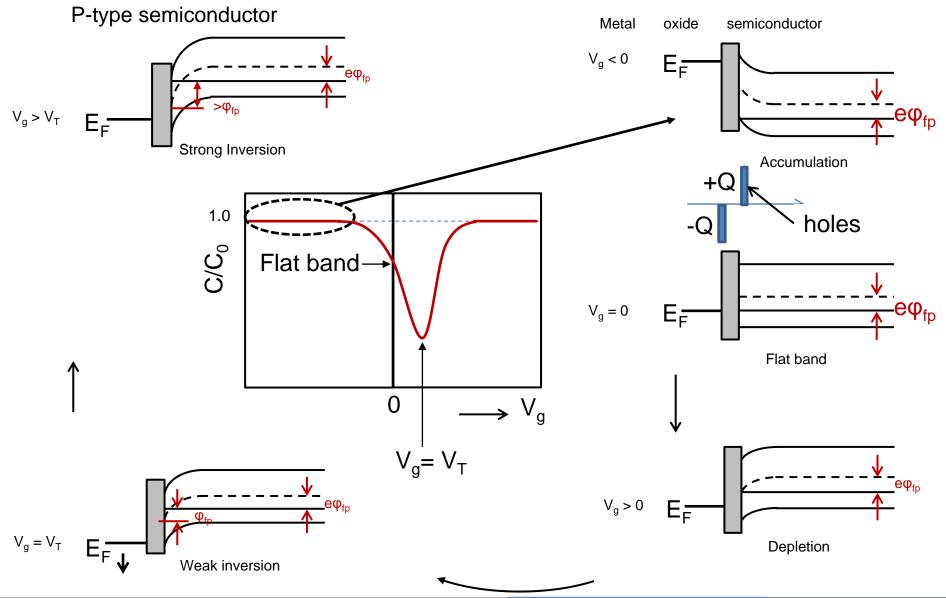
 $V_{\rm FB}$: flat band voltage, will be discussed later

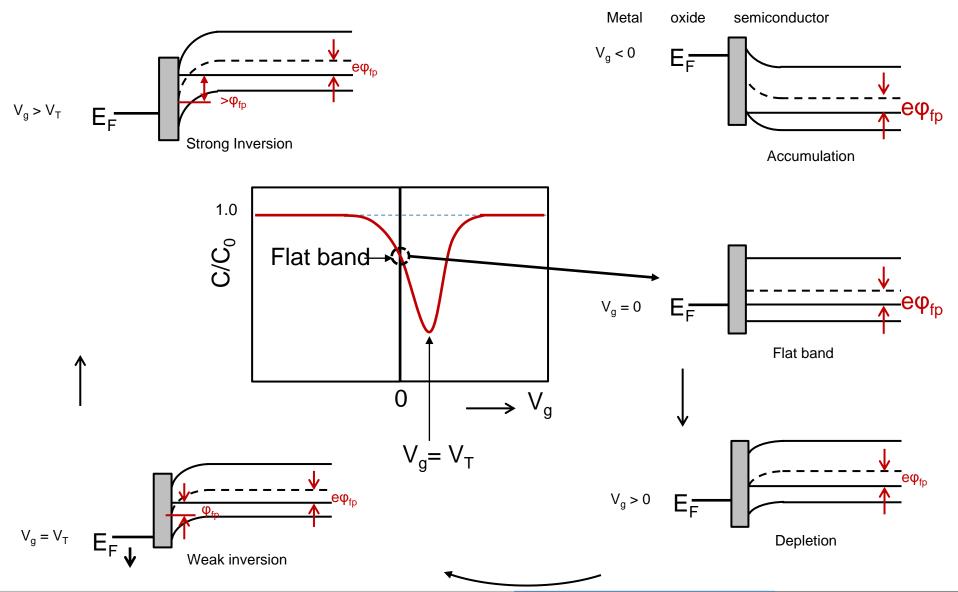


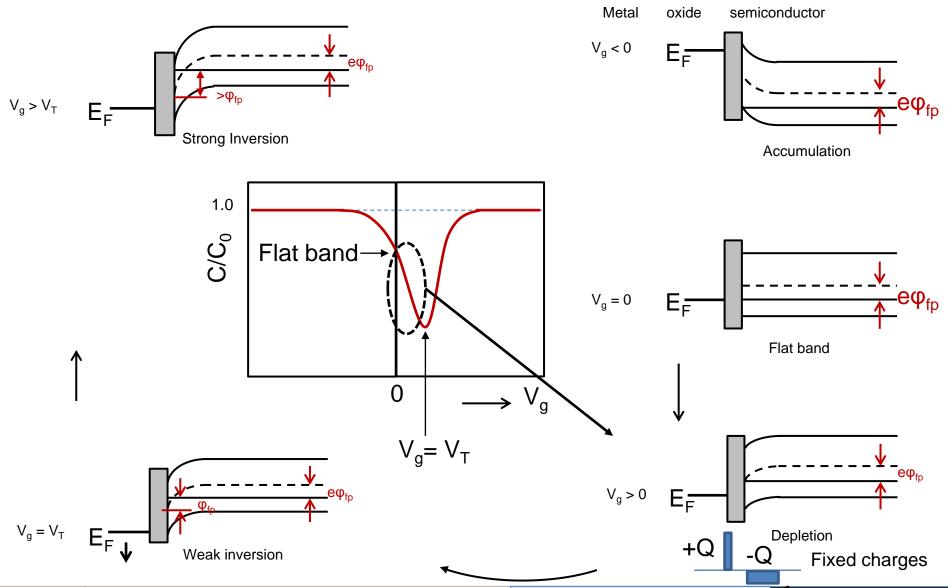
Threshold Voltage (V_T)

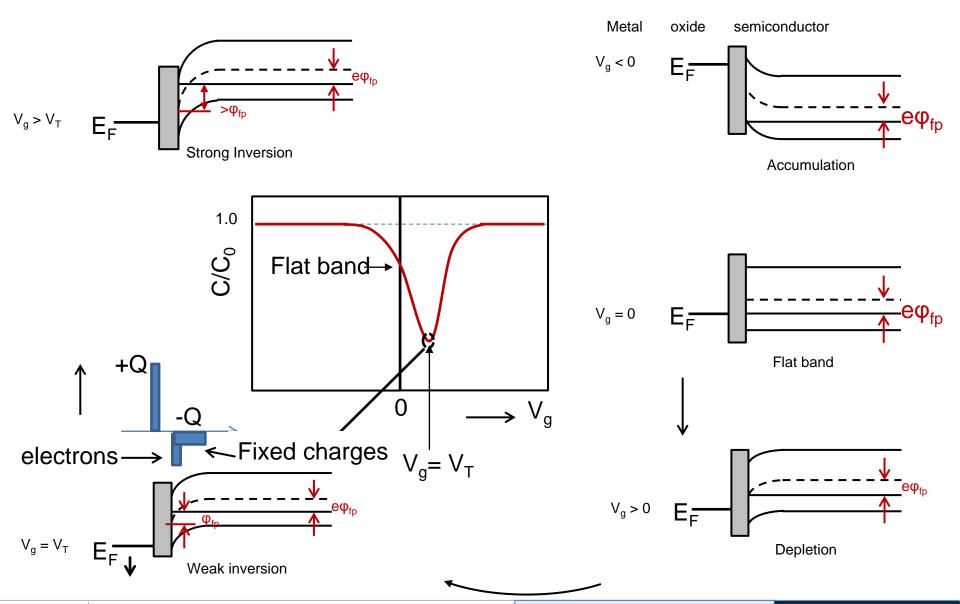


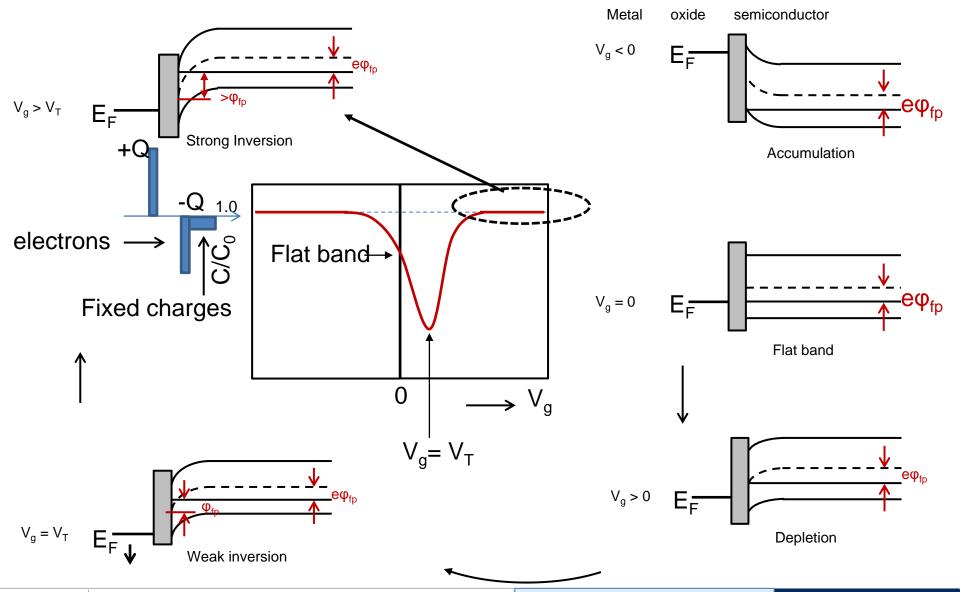






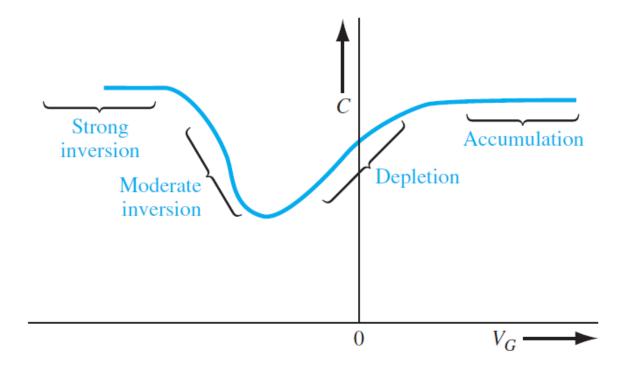




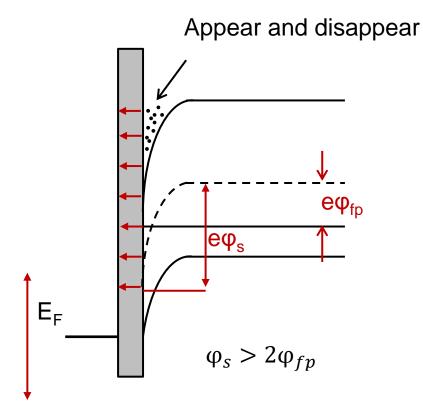


Capacitance vs Voltage (CV) curve

n-type semiconductor



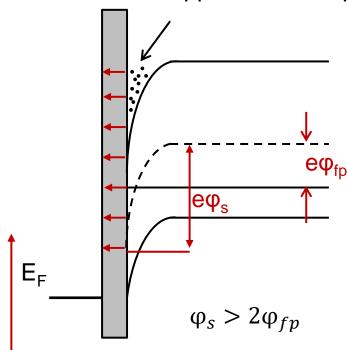
Question:



Where are the electrons coming from and going to?

Question:

Appear and disappear

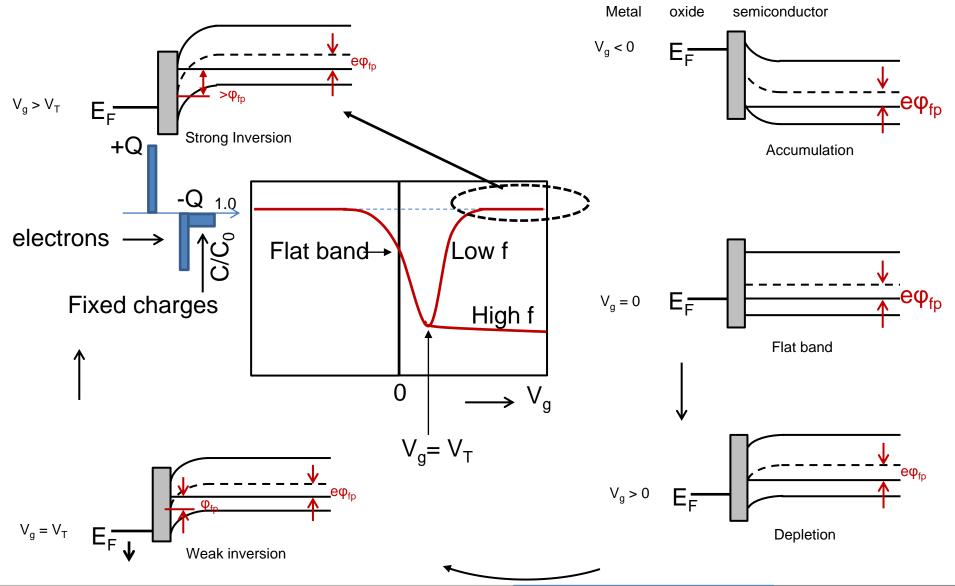


Where are the electrons coming from and going to?

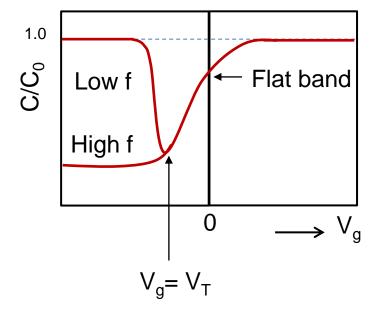
Source:

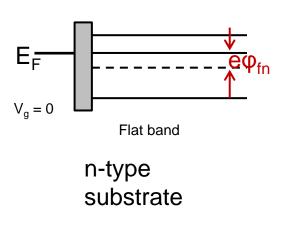
- diffusion of minority carrier electrons from the p-type substrate across the space charge region
- 2. thermal generation of electron-hole pairs within the space charge region

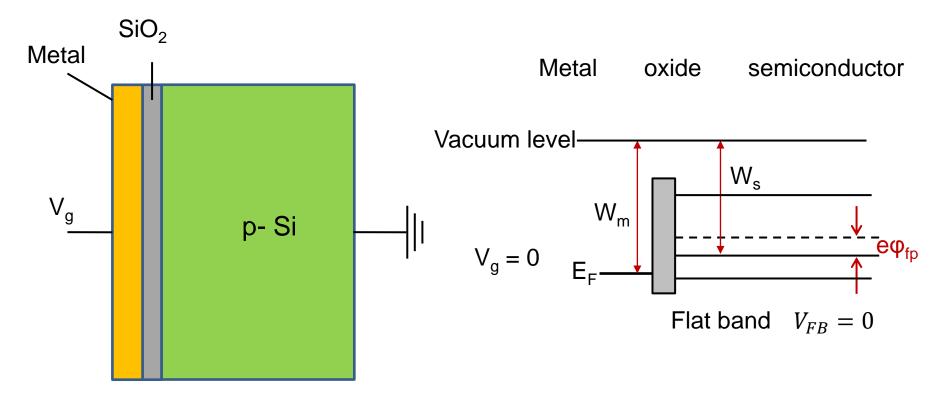
C-V characteristics: frequency dependent, p-type substrate



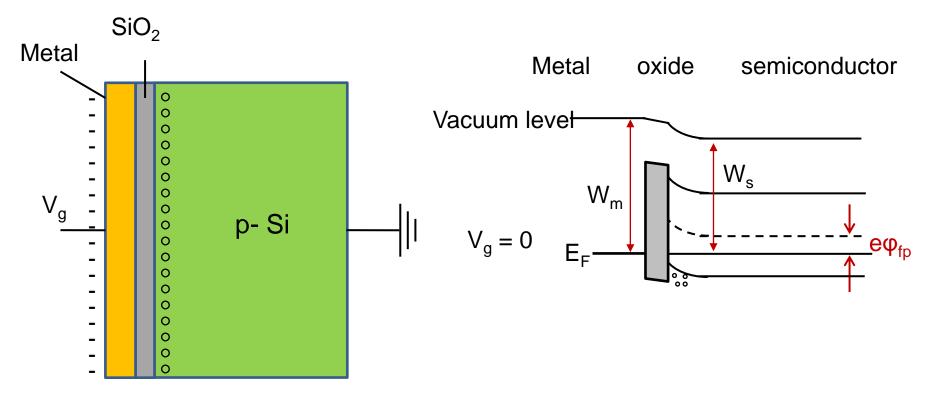
C-V characteristics: n-type substrate



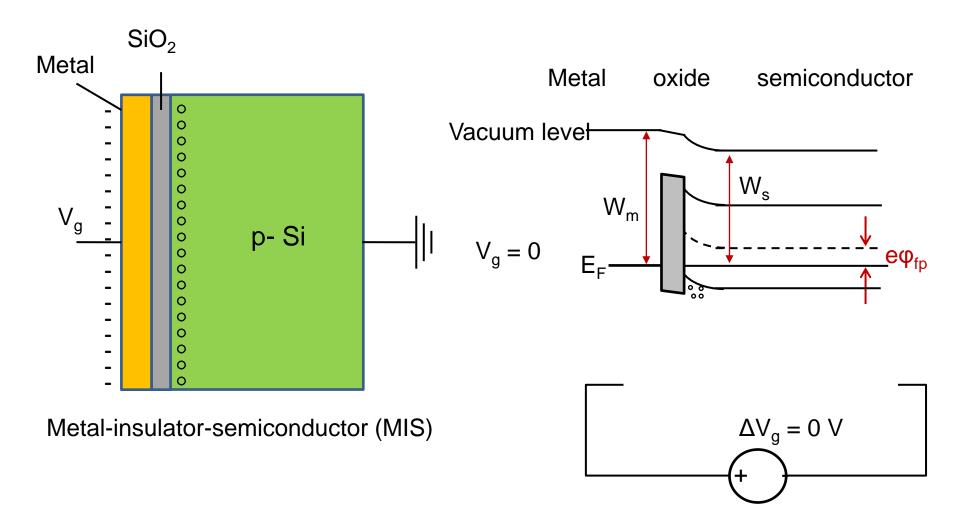




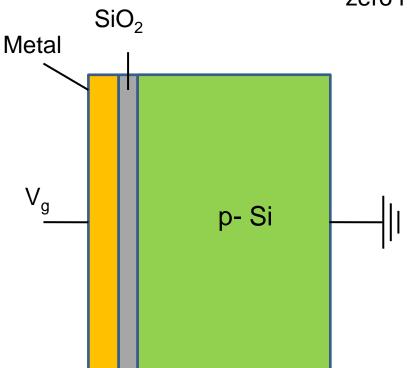
Metal-insulator-semiconductor (MIS)



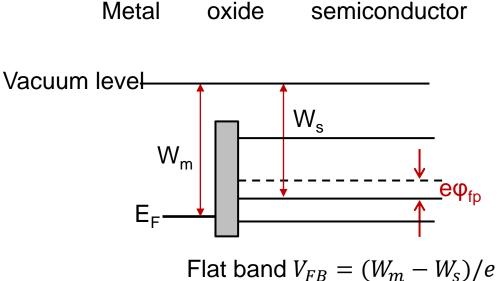
Metal-insulator-semiconductor (MIS)



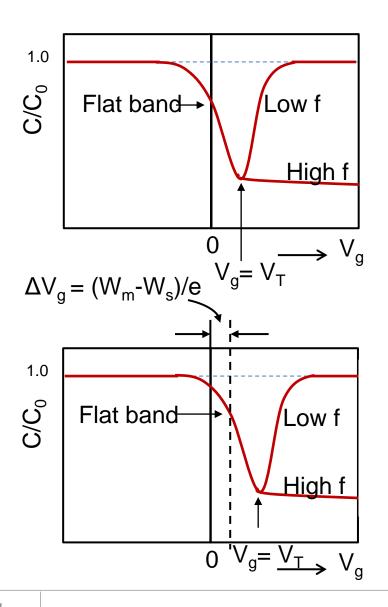
Flat band voltage: applied gate voltage such that there is no band bending in the semiconductor, and zero net space charge in this region



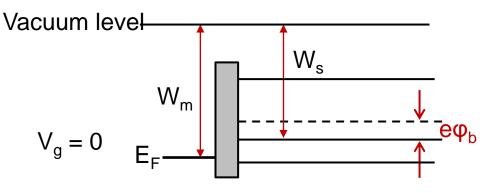
Metal-insulator-semiconductor (MIS)



$$\Delta V_{g} = (W_{m} - W_{s})/e = \Phi_{ms}$$

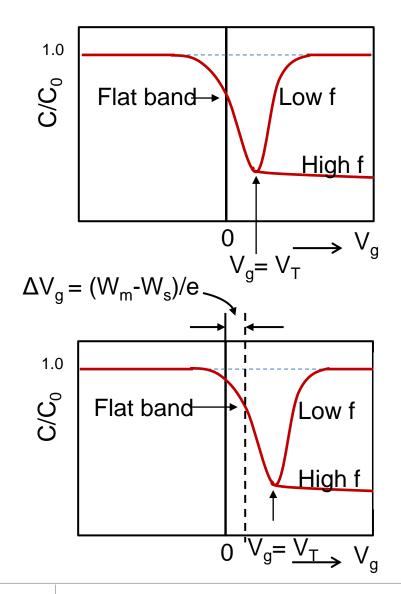


Metal oxide semiconductor



Flat band $V_{FB} = (W_m - W_s)/e$

$$\Delta V_g = (W_m - W_s)/e = \Phi_{ms}$$

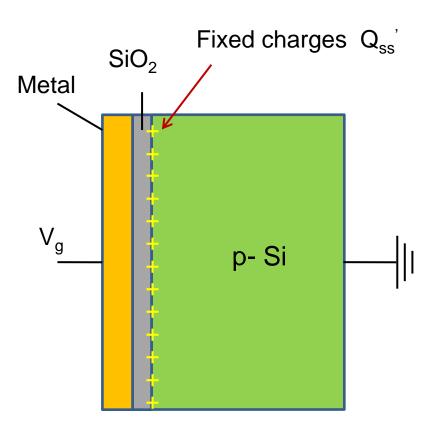


Same work function

$$V_T = 2\phi_{fp} + t_{ox} \sqrt{\frac{4eN_a \varepsilon_{Si} \phi_{fp}}{\varepsilon_{ox}^2}} = 2\phi_{fp} + \frac{|Q_{SD}|}{C_{ox}}$$

Different work function

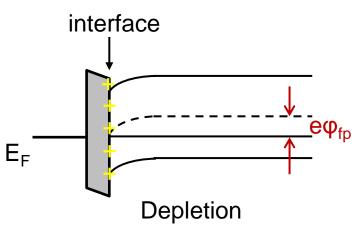
$$V_T = 2\phi_{fp} + t_{ox} \sqrt{\frac{4eN_a \varepsilon_{Si} \phi_{fp}}{\varepsilon_{ox}^2}} + V_{FB}$$
$$= 2\phi_{fp} + \frac{|Q_{SD}|}{C_{ox}} + \phi_{ms}$$

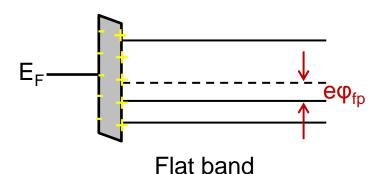


Metal-insulator-semiconductor (MIS)

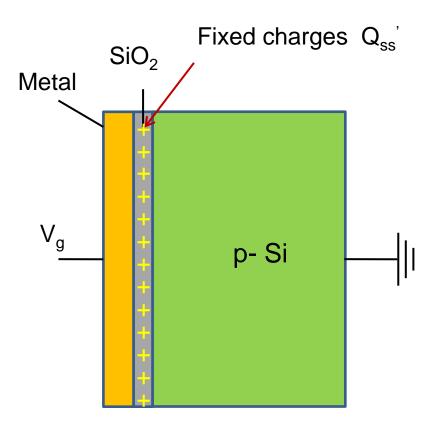
Same work function

Metal oxide semiconductor





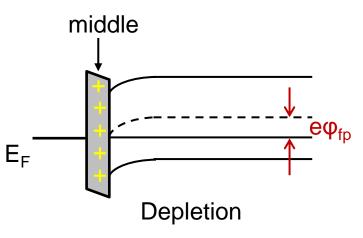
$$V_g = V_{FB} = -Q_{ss}'/C$$

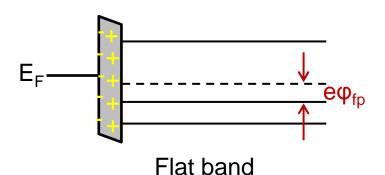


Metal-insulator-semiconductor (MIS)

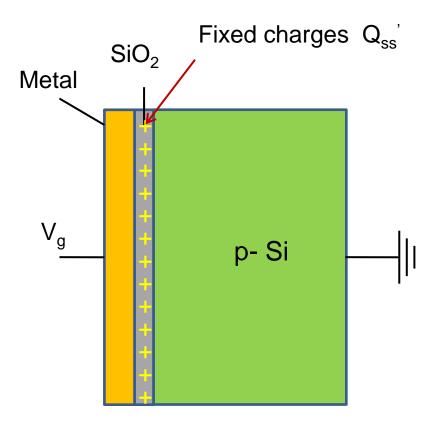
Same work function

Metal oxide semiconductor





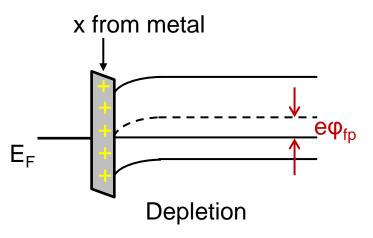
$$V_g = V_{FB} = -Q_{ss}'/2C$$

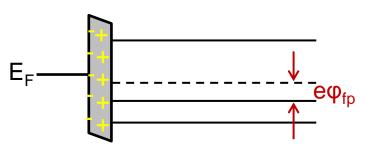


Metal-insulator-semiconductor (MIS)

Same work function

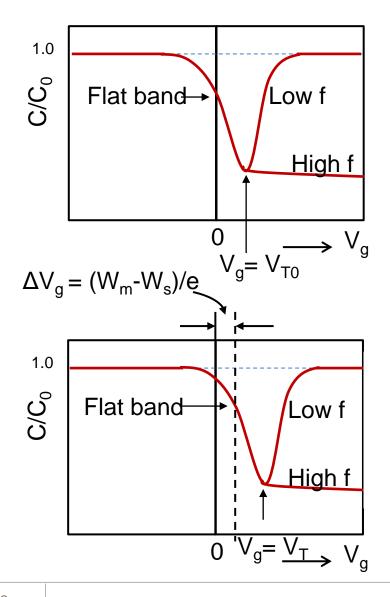
Metal oxide semiconductor





Flat band

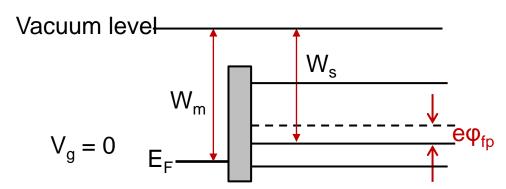
$$V_g = V_{FB} = -\frac{Q_{ss}'}{C} \cdot \frac{x}{d}$$



Different work function

Consider the trapped charge per unit area in the oxide $Q_{\rm ss}$ '

Metal oxide semiconductor



Flat band

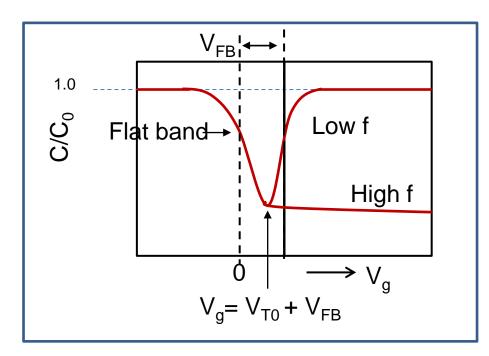
$$V_{FB} = \phi_{ms} - rac{Q_{ss}'}{C_{
m ox}}$$

$$V_{FB} = \frac{W_m - W_s}{e} - \frac{Q'_{SS}}{C_{ox}}$$

The flat-band voltage shifts to more negative voltages for a positive fixed oxide charge

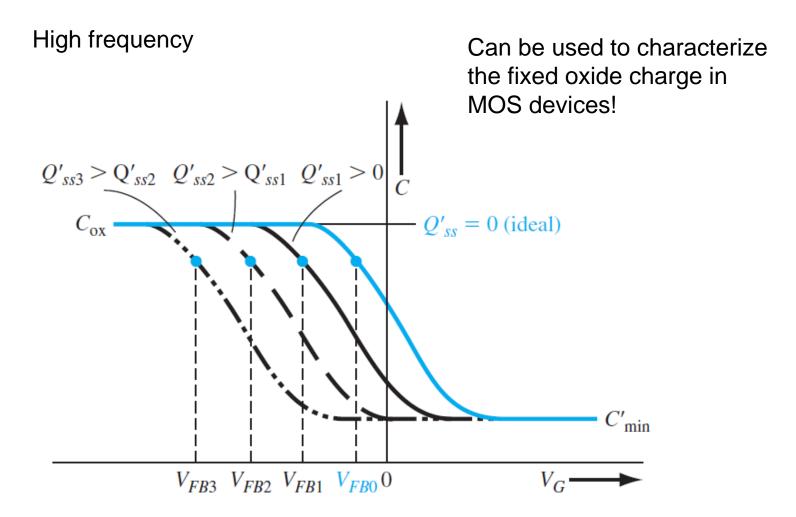
Same work function 1.0 Flat band-Low f High f $V_g = V_{T0}$ $\Delta V_g = (W_m - W_s)/e_s$ 1.0 Flat band Low f High f

Different work function

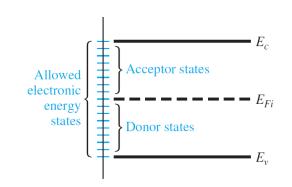


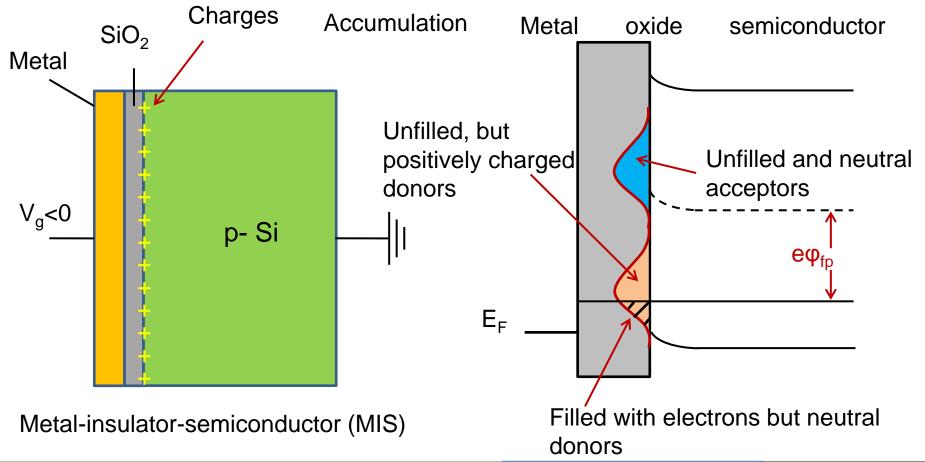
Different work function, with oxide charges

$$V_T = 2\phi_{fp} + t_{ox} \sqrt{\frac{4eN_a \varepsilon_{Si} \phi_{fp}}{\varepsilon_{ox}^2}} + V_{FB}$$
$$= 2\phi_{fp} + \frac{|Q_{SD}|}{C_{ox}} + \phi_{ms} - \frac{Q_{ss}'}{C_{ox}}$$

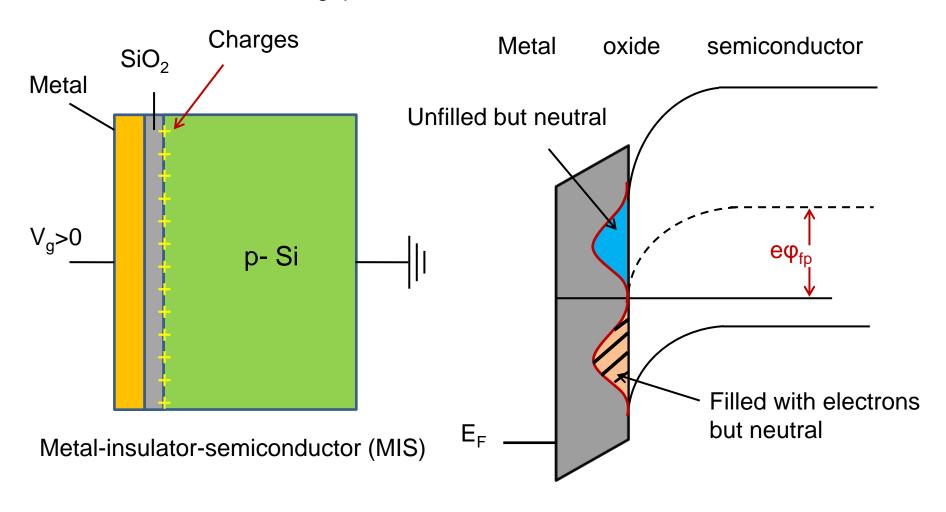


An acceptor state is neutral if the Fermi level is below the state and becomes negatively charged if the Fermi level is above the state. A donor state is neutral if the Fermi level is above the state and becomes positively charged if the Fermi level is below the state.

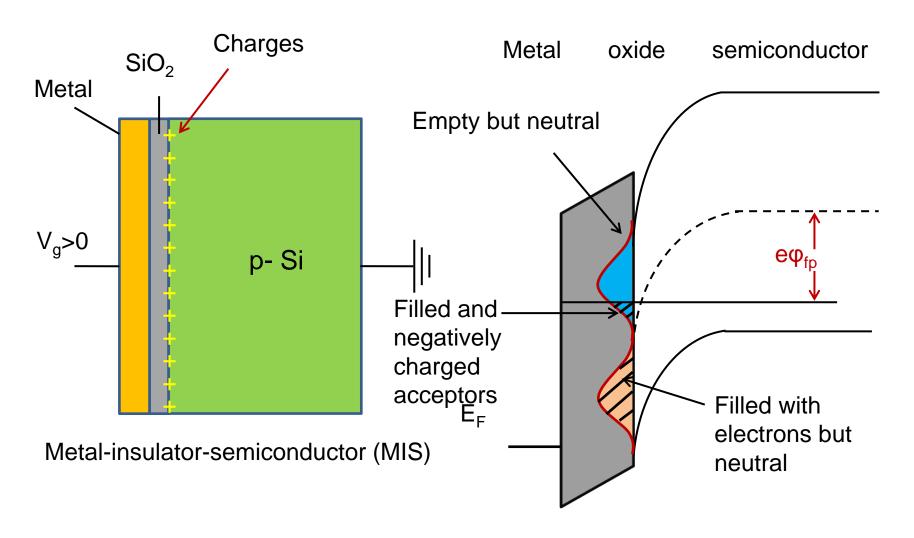


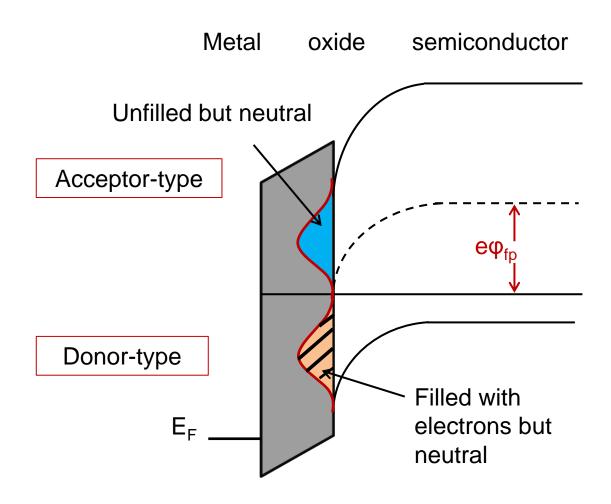


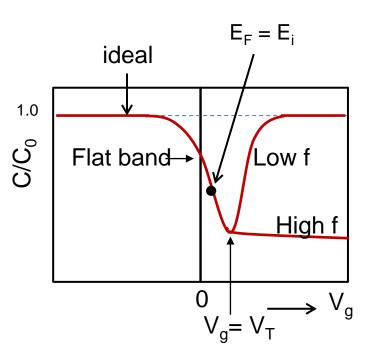
Midgap: all interface states are neutral

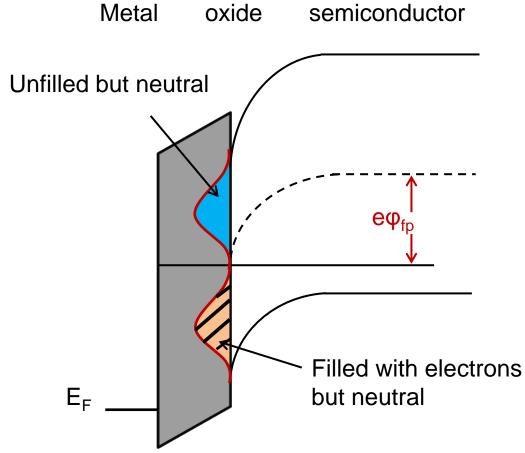


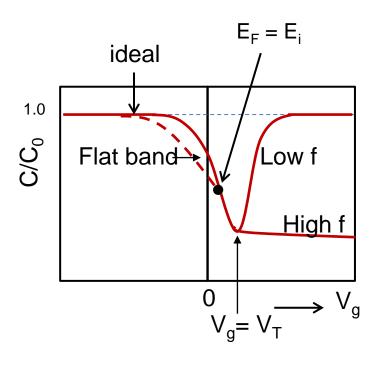
Inversion

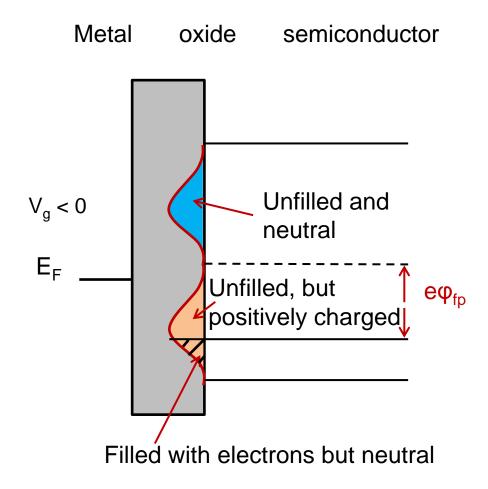


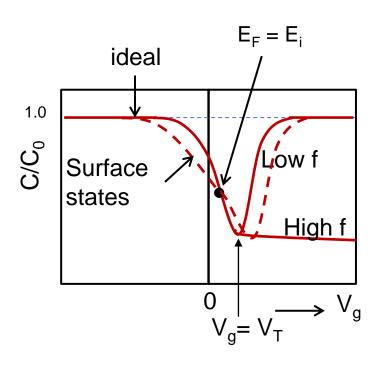


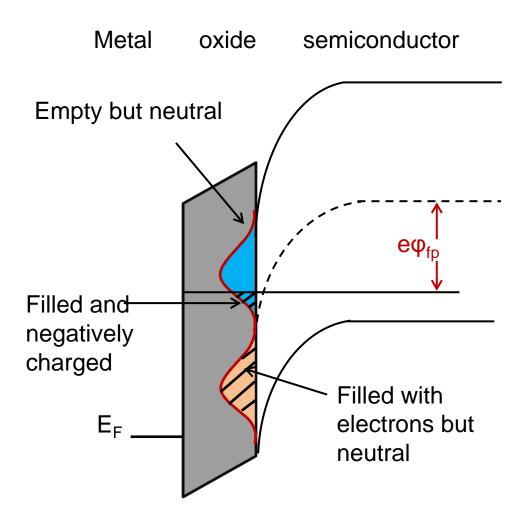




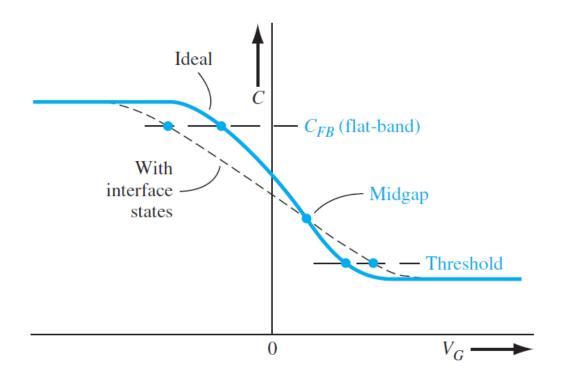








"Smeared out" C-V curves



Can be used to measure the interface states in MOS devices